



US00D952608S

(12) **United States Design Patent** (10) **Patent No.:** **US D952,608 S**  
**Feng et al.** (45) **Date of Patent:** **\*\* May 24, 2022**

(54) **BLUETOOTH® HEADSET ASSEMBLY**

(71) Applicant: **LUXSHARE PRECISION INDUSTRY CO., LTD.**, Shenzhen (CN)

(72) Inventors: **Yun Feng**, Dongguan (CN); **ZhenHua Liu**, Dongguan (CN); **Yong Huang**, Dongguan (CN)

(73) Assignee: **LUXSHARE PRECISION INDUSTRY CO., LTD.**, Shenzhen (CN)

(\*\*) Term: **15 Years**

(21) Appl. No.: **29/720,234**

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(30) **Foreign Application Priority Data**

Jul. 18, 2019 (CN) ..... 201930383269.6

(51) **LOC (13) Cl.** ..... **14-01**

(52) **U.S. Cl.**  
USPC ..... **D14/223**

(58) **Field of Classification Search**  
USPC ... D14/205, 207, 217, 221, 223, 224, 224.1, D14/225; D24/173, 174

(Continued)

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*Primary Examiner* — Messina L Smith

(74) *Attorney, Agent, or Firm* — Birch, Stewart, Kolasch & Birch, LLP

(57) **CLAIM**

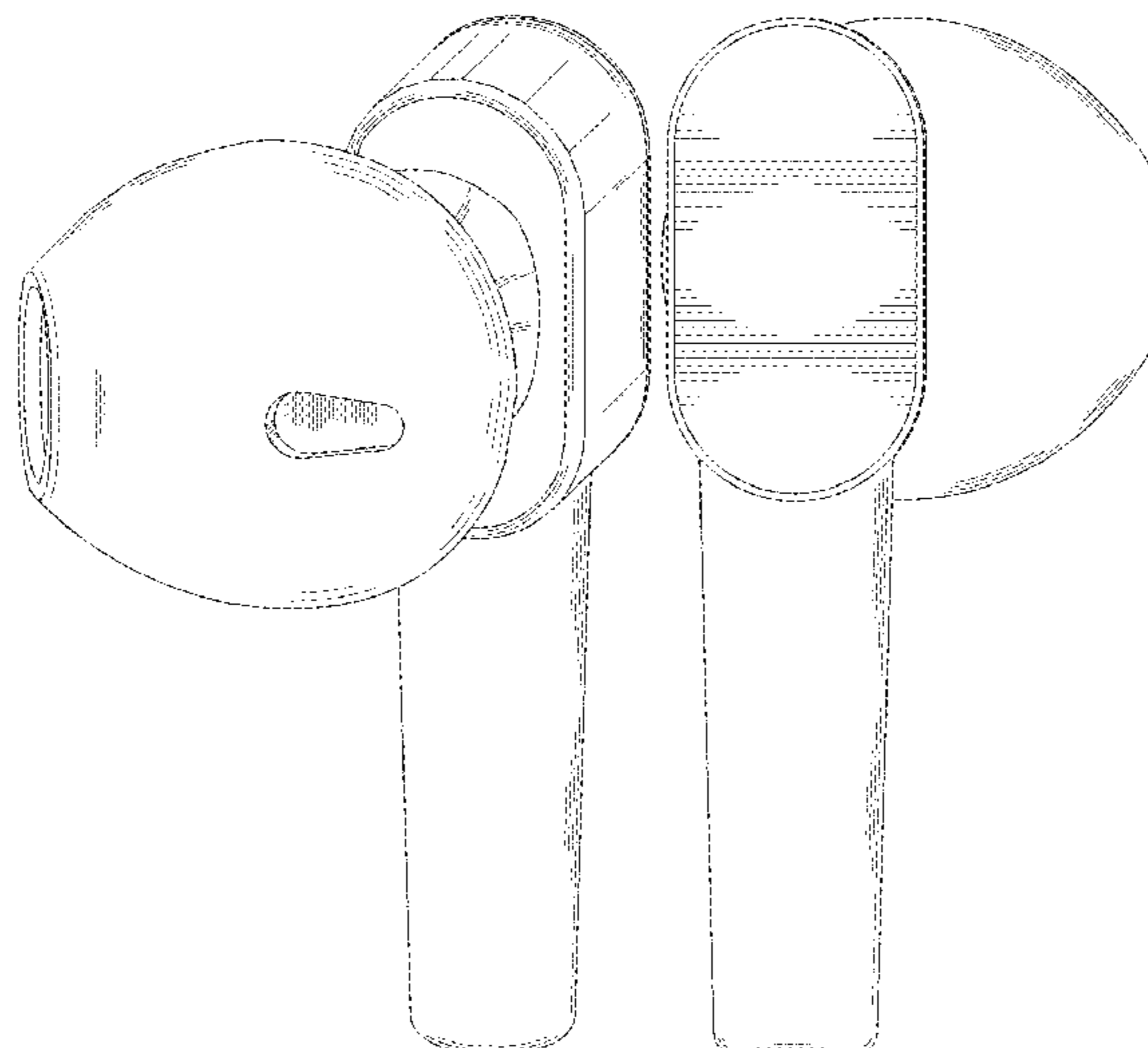
The ornamental design for a Bluetooth® headset assembly, as shown and described.

**DESCRIPTION**

FIG. 1 is a front elevational view of a Bluetooth® headset assembly shown in a first embodiment; FIG. 2 is a rear elevational view thereof; FIG. 3 is a right side view thereof; FIG. 4 is a left side view thereof; FIG. 5 is a top view thereof; FIG. 6 is a bottom view thereof; FIG. 7 is a perspective view thereof; FIG. 8 is a front elevational view of the Bluetooth® headset assembly shown in a second embodiment; FIG. 9 is a rear elevational view thereof; FIG. 10 is a right side view thereof; FIG. 11 is a left side view thereof; FIG. 12 is a top view thereof; FIG. 13 is a bottom view thereof; FIG. 14 is a perspective view thereof; and, FIG. 15 is a perspective view of the first and second embodiments of the Bluetooth® headset assembly, shown in a state of use.

The broken lines showing of the case in FIG. 15 depicts environment and forms no part of the claimed design. All other broken lines shown in the drawings depict portions of the Bluetooth® headset assembly that form no part of the claimed design.

**1 Claim, 15 Drawing Sheets**





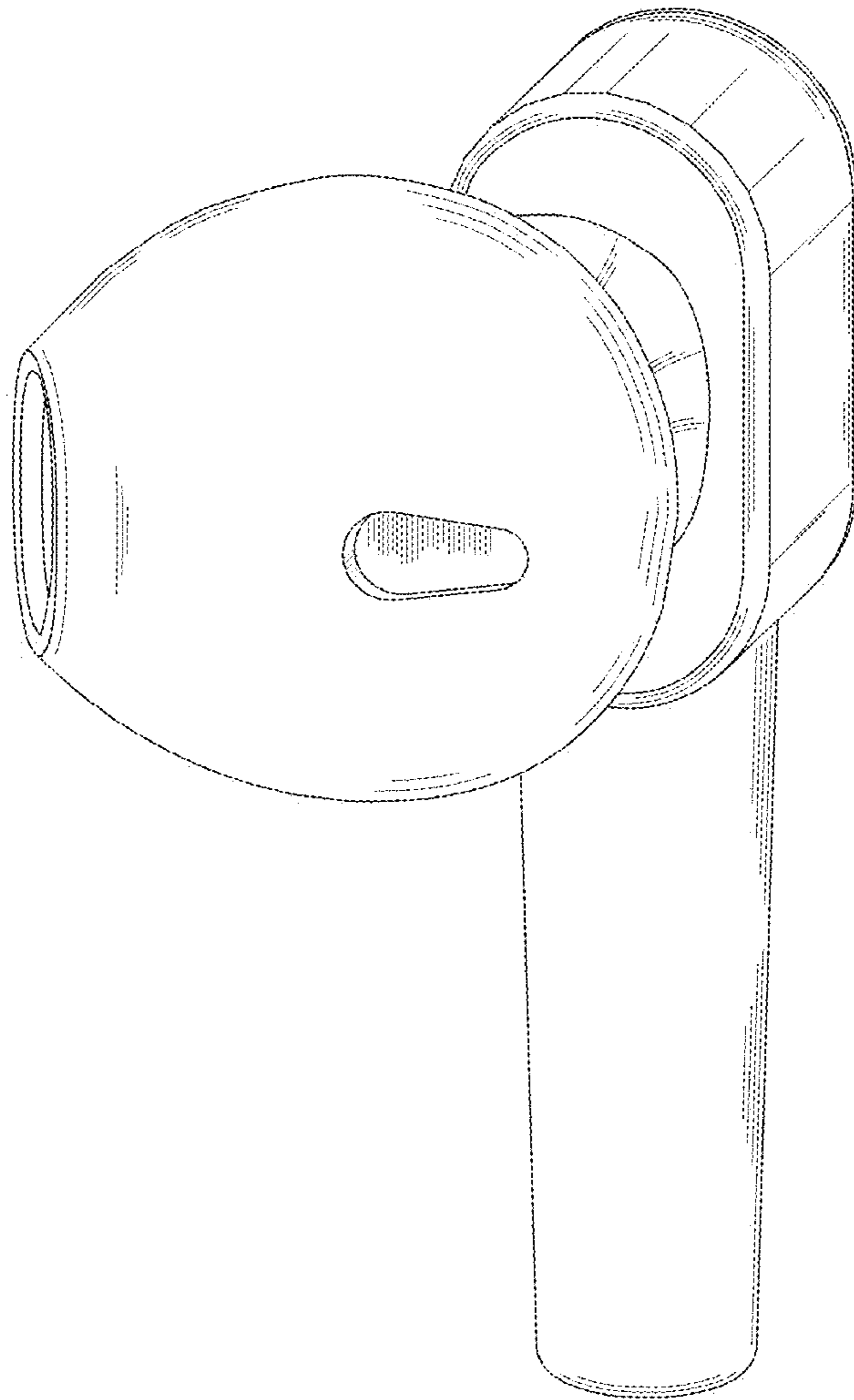


FIG. 1

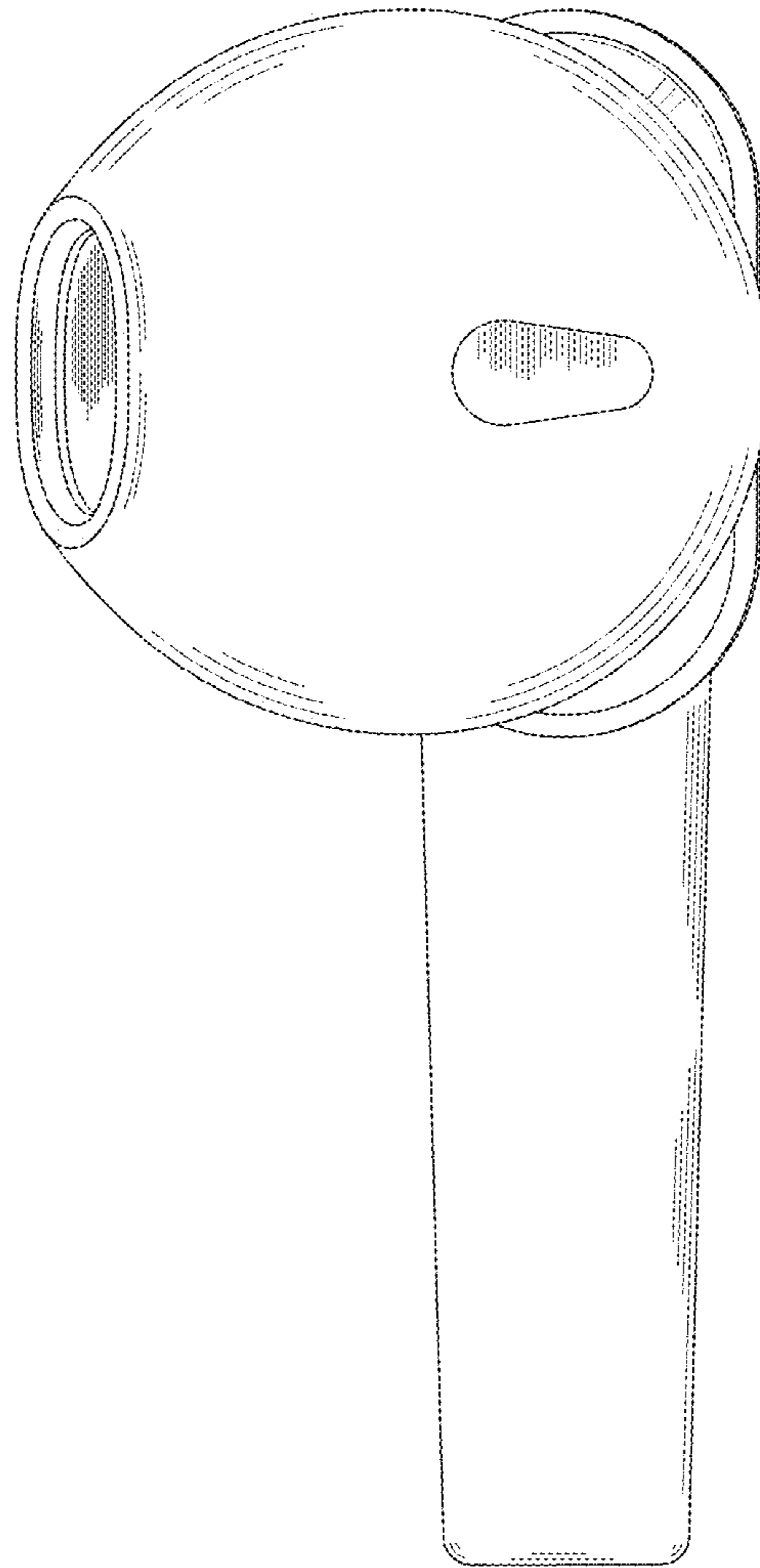


FIG. 2

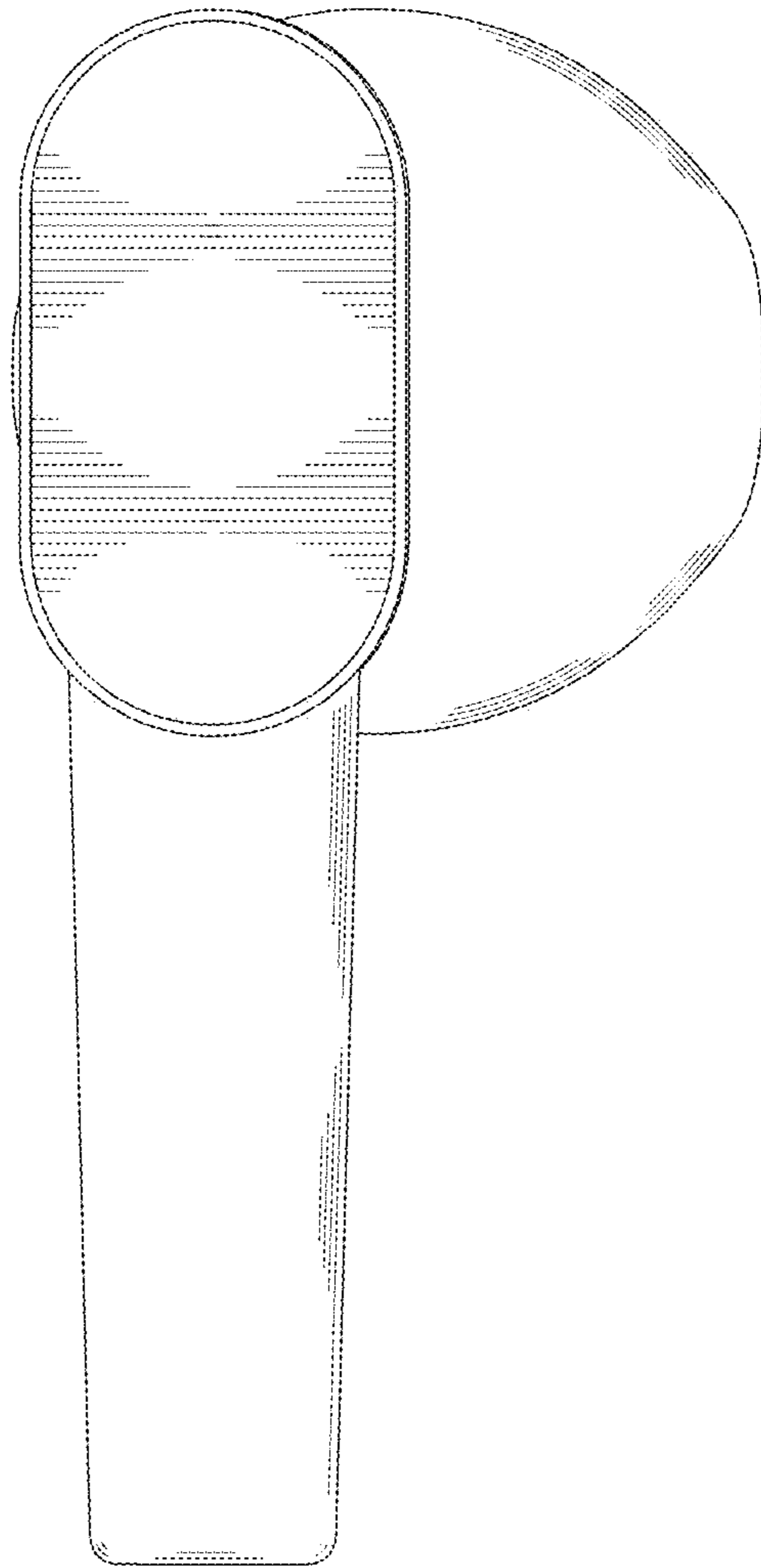


FIG. 3

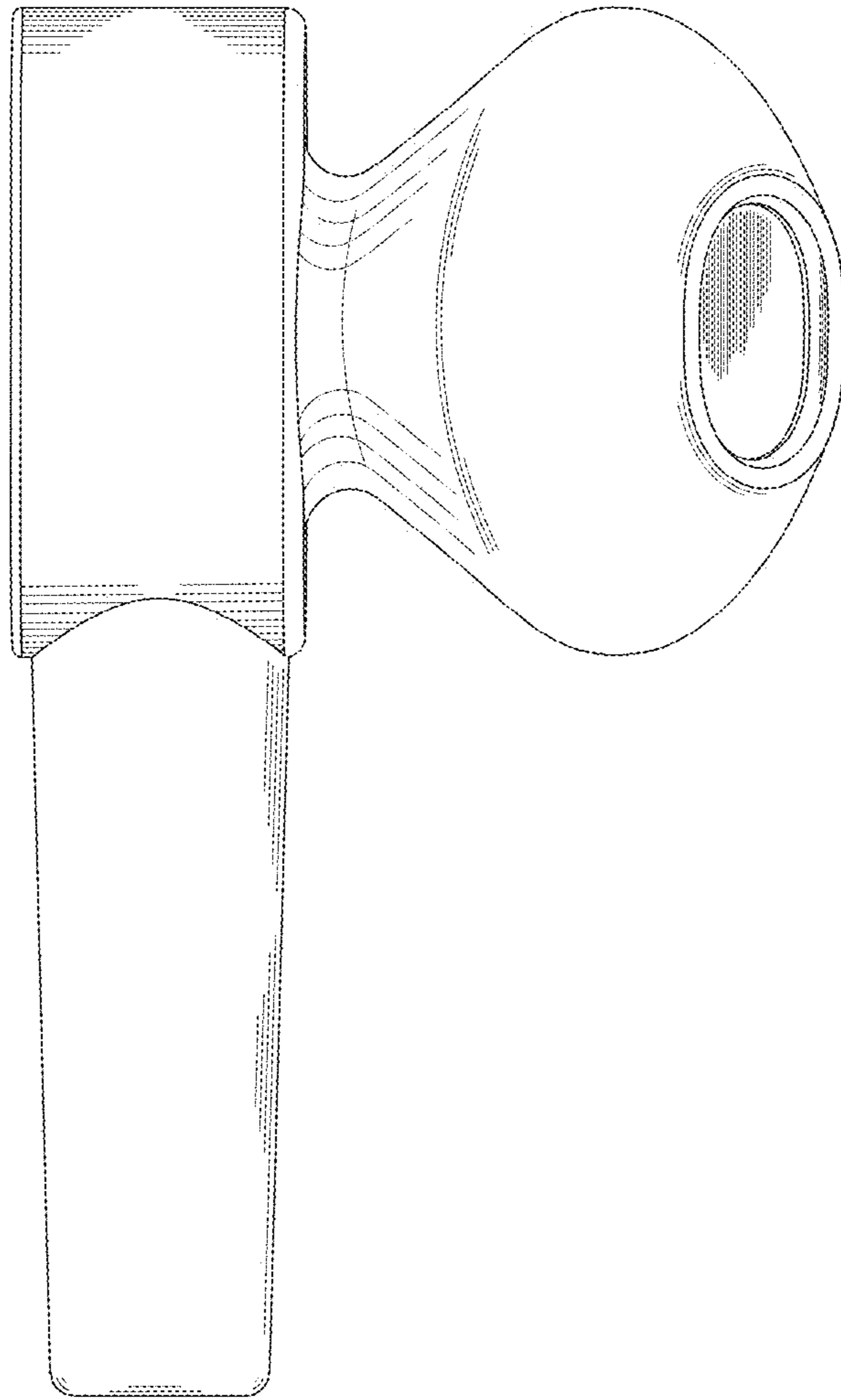


FIG. 4

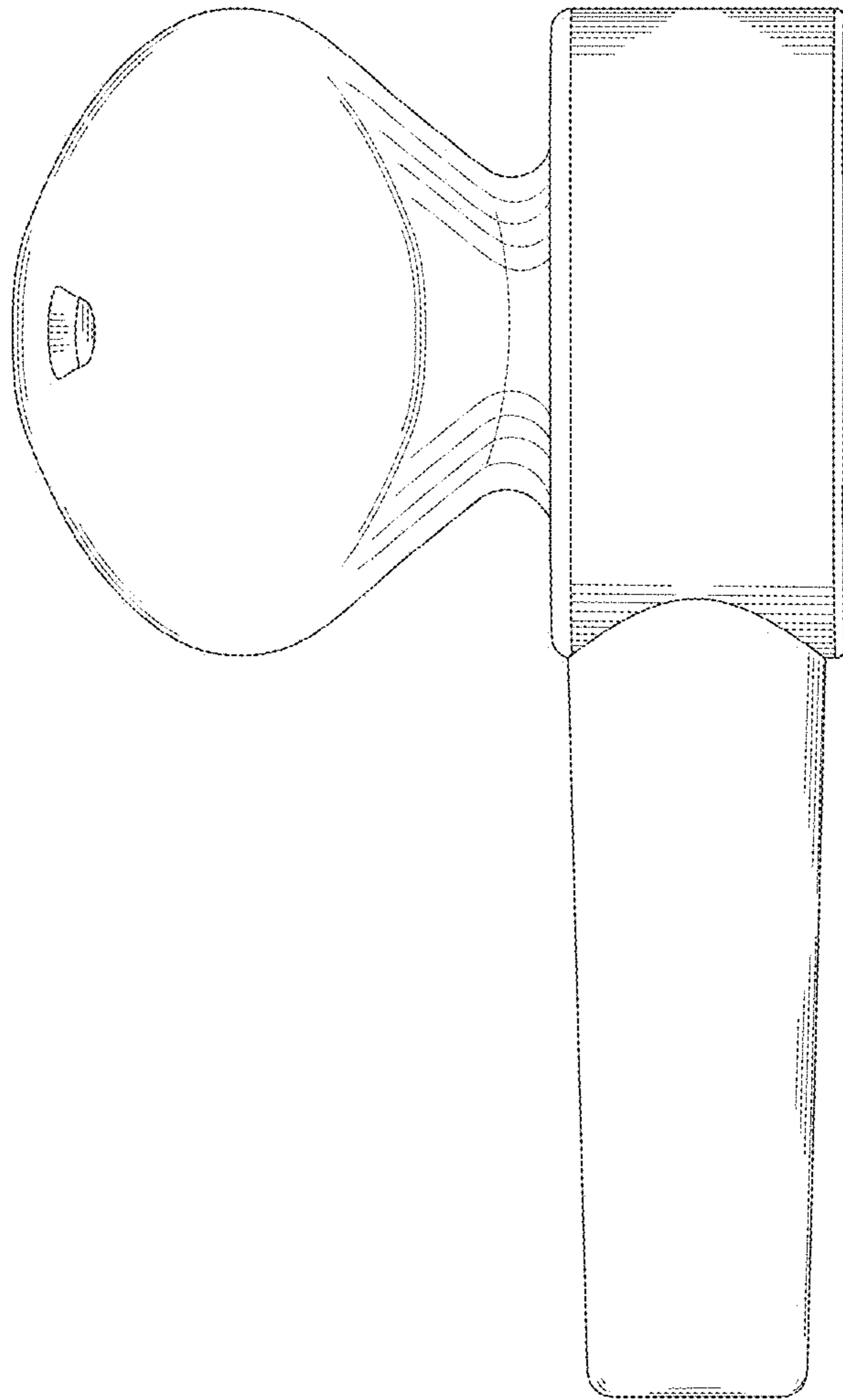


FIG. 5

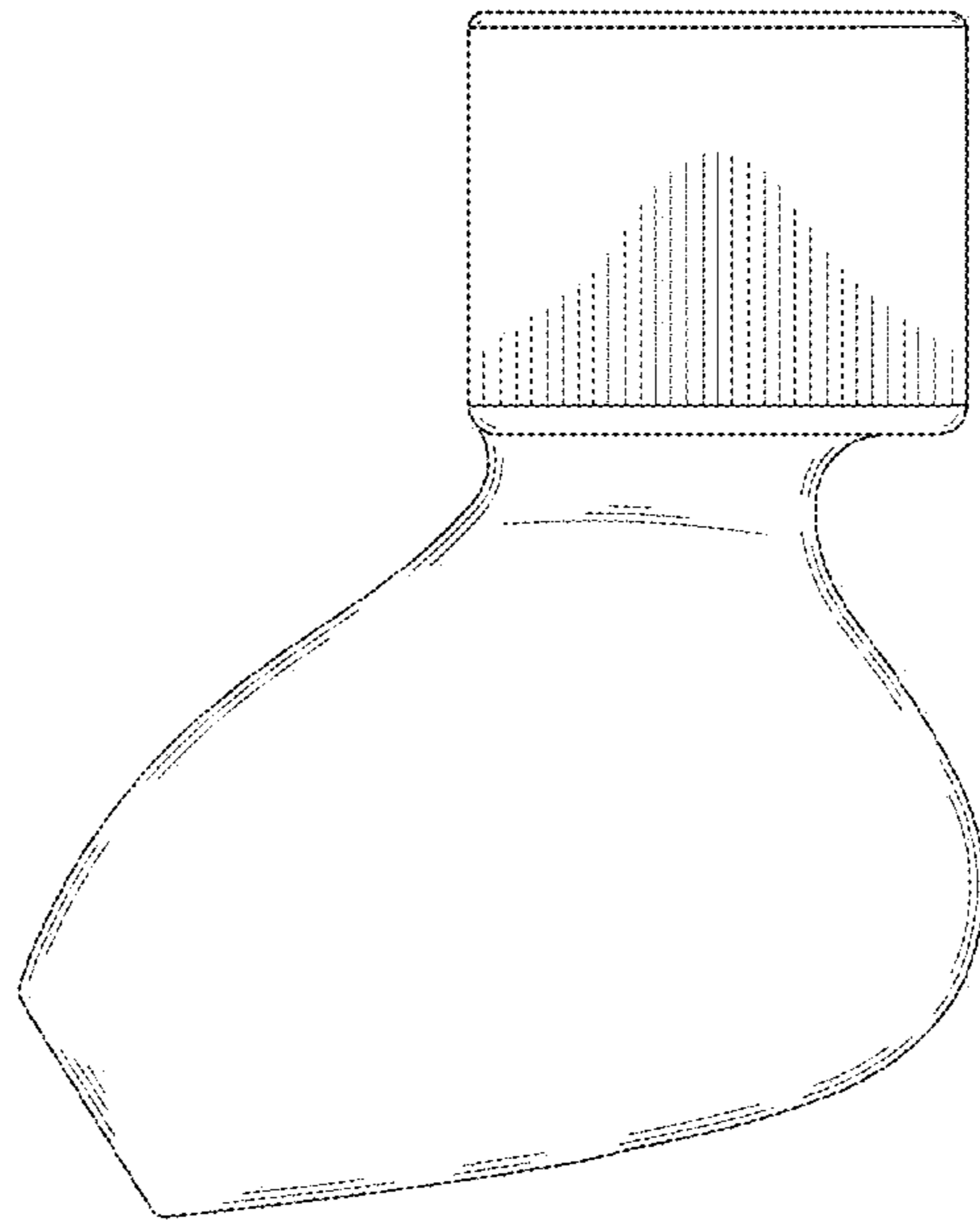


FIG. 6



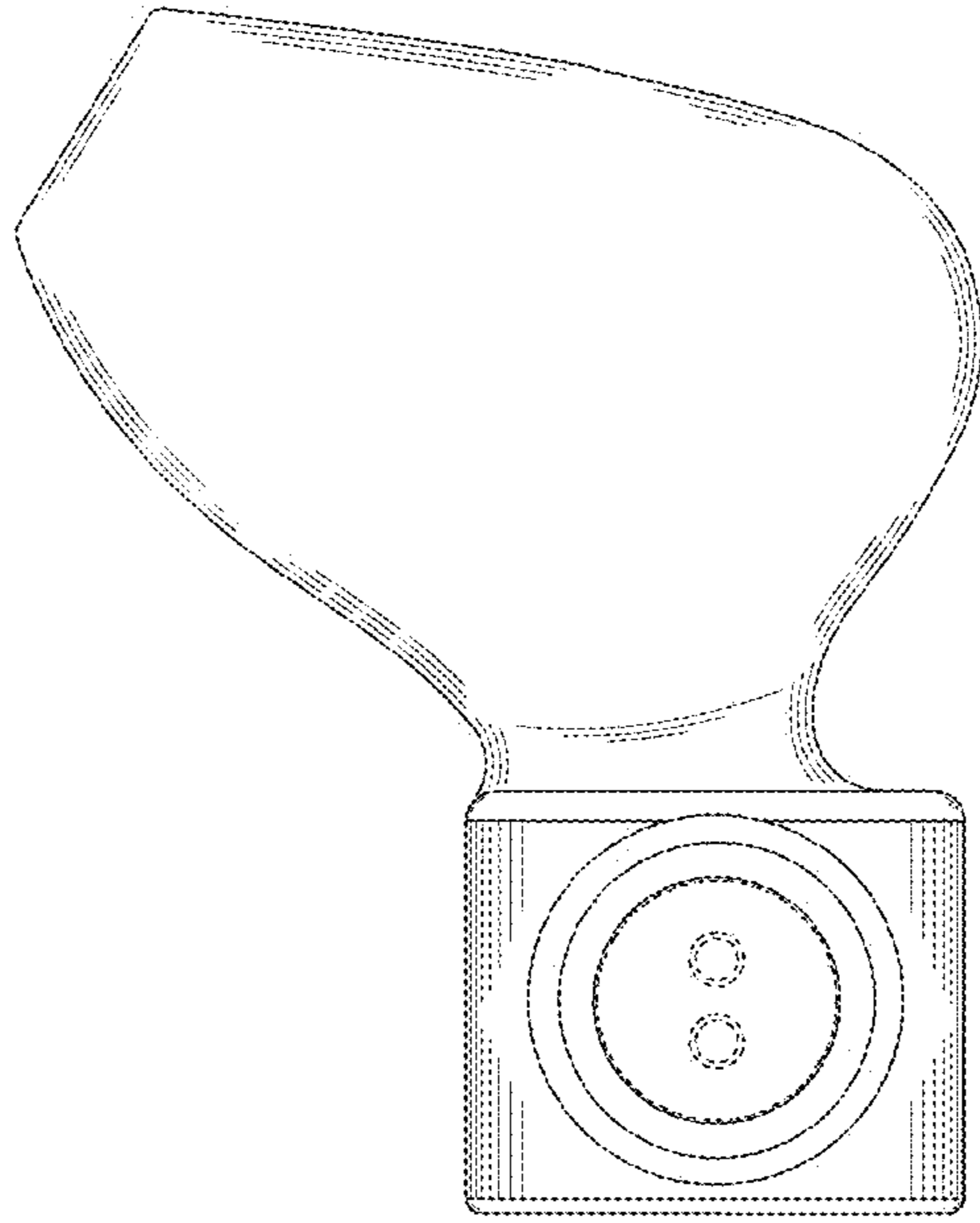


FIG. 7

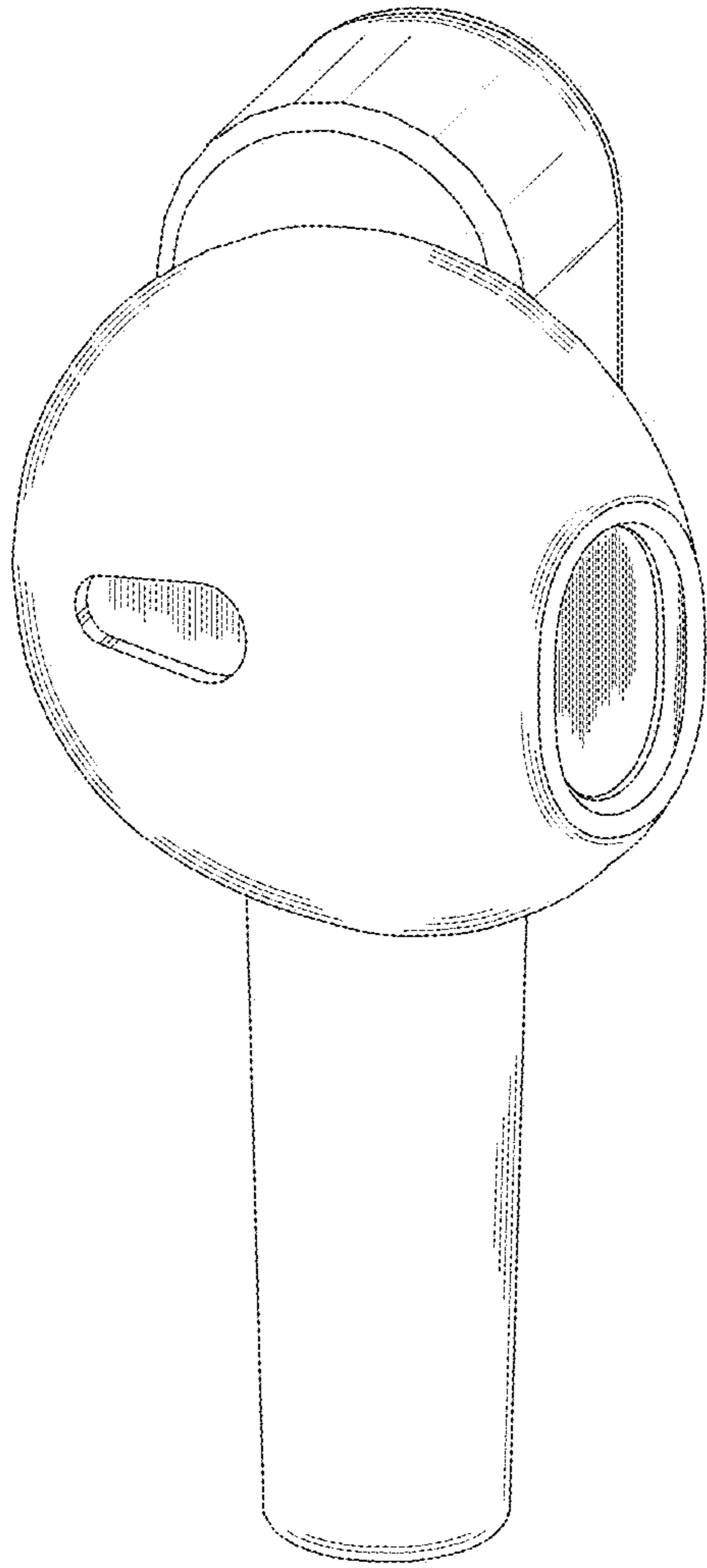


FIG. 8

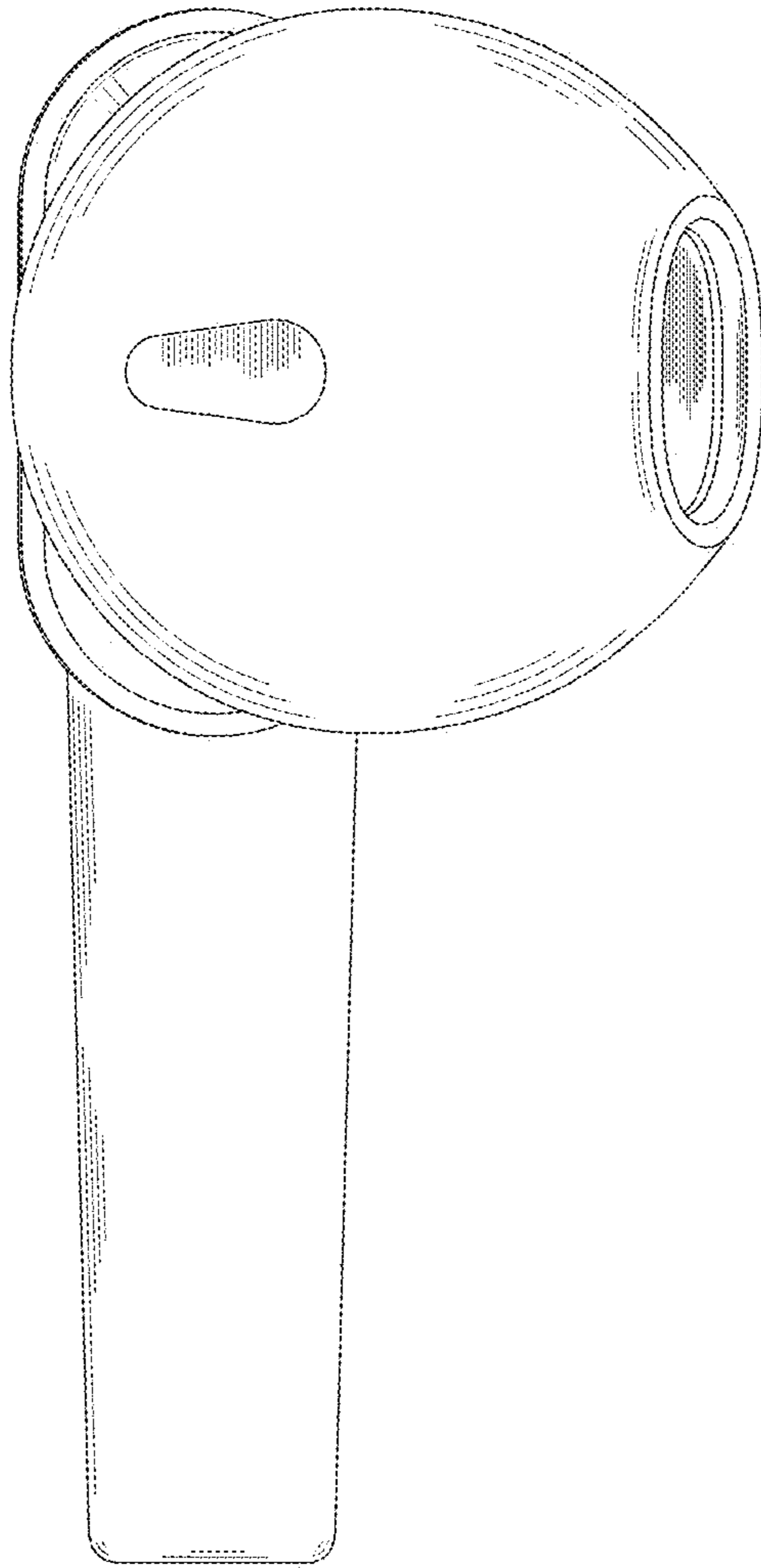


FIG. 9

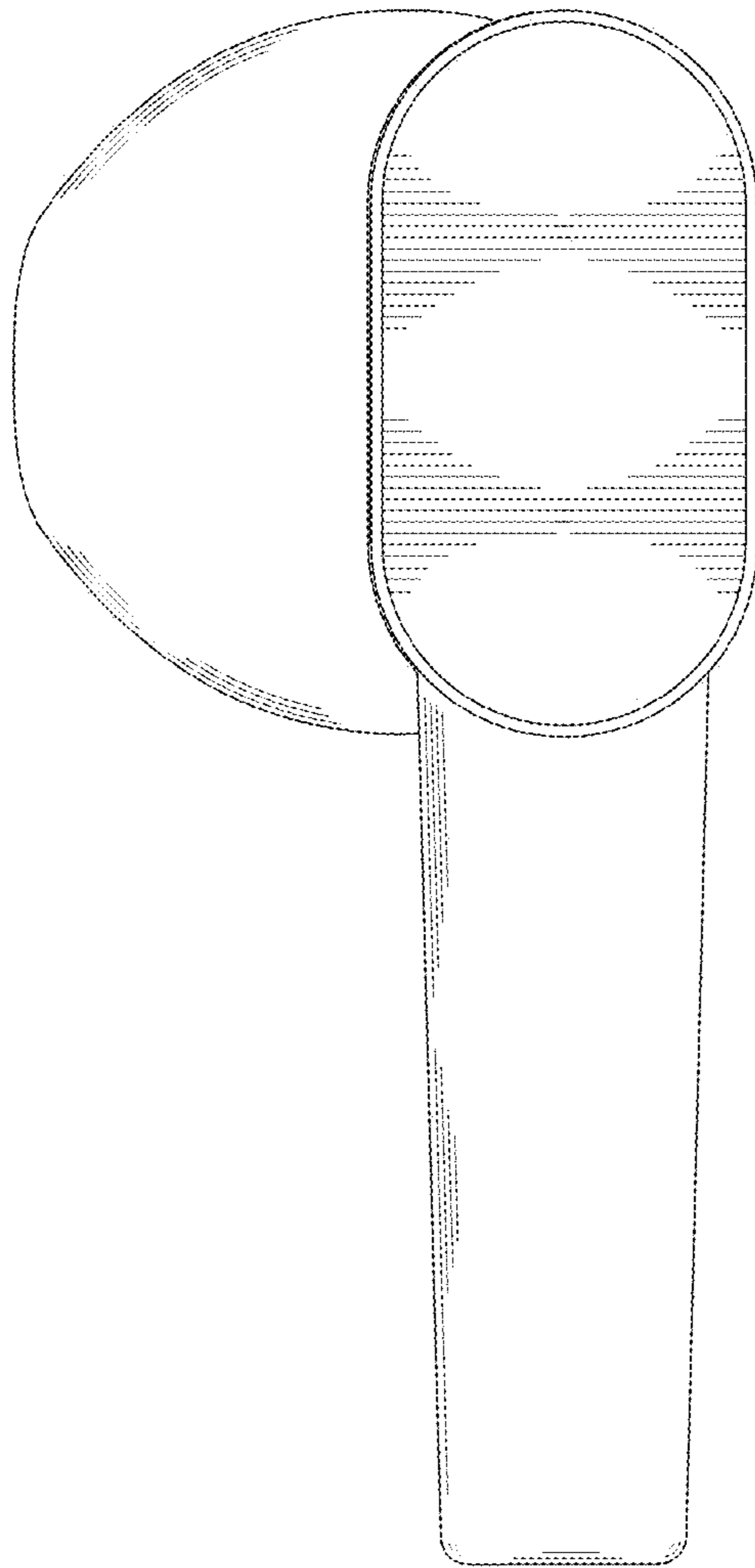


FIG. 10

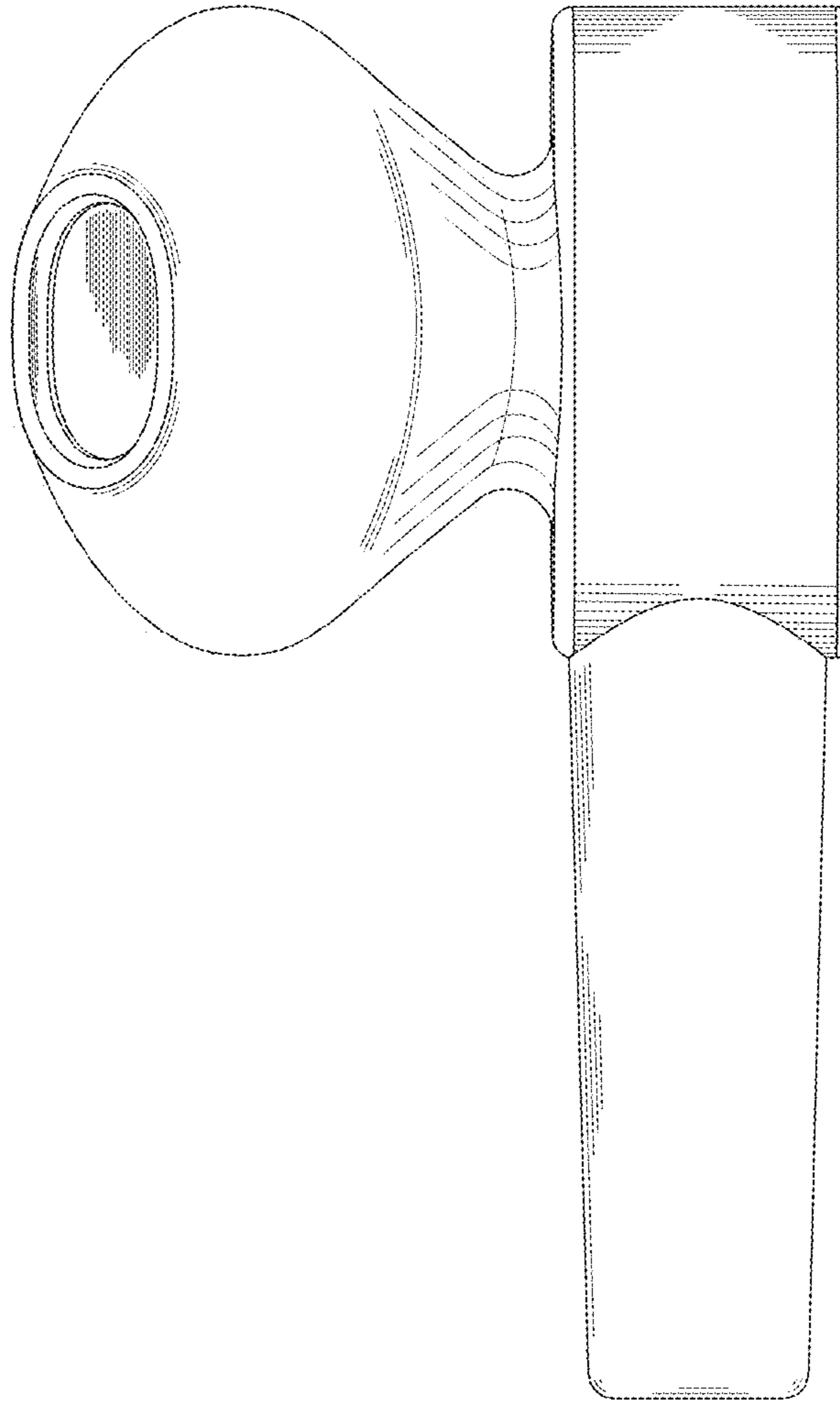


FIG. 11

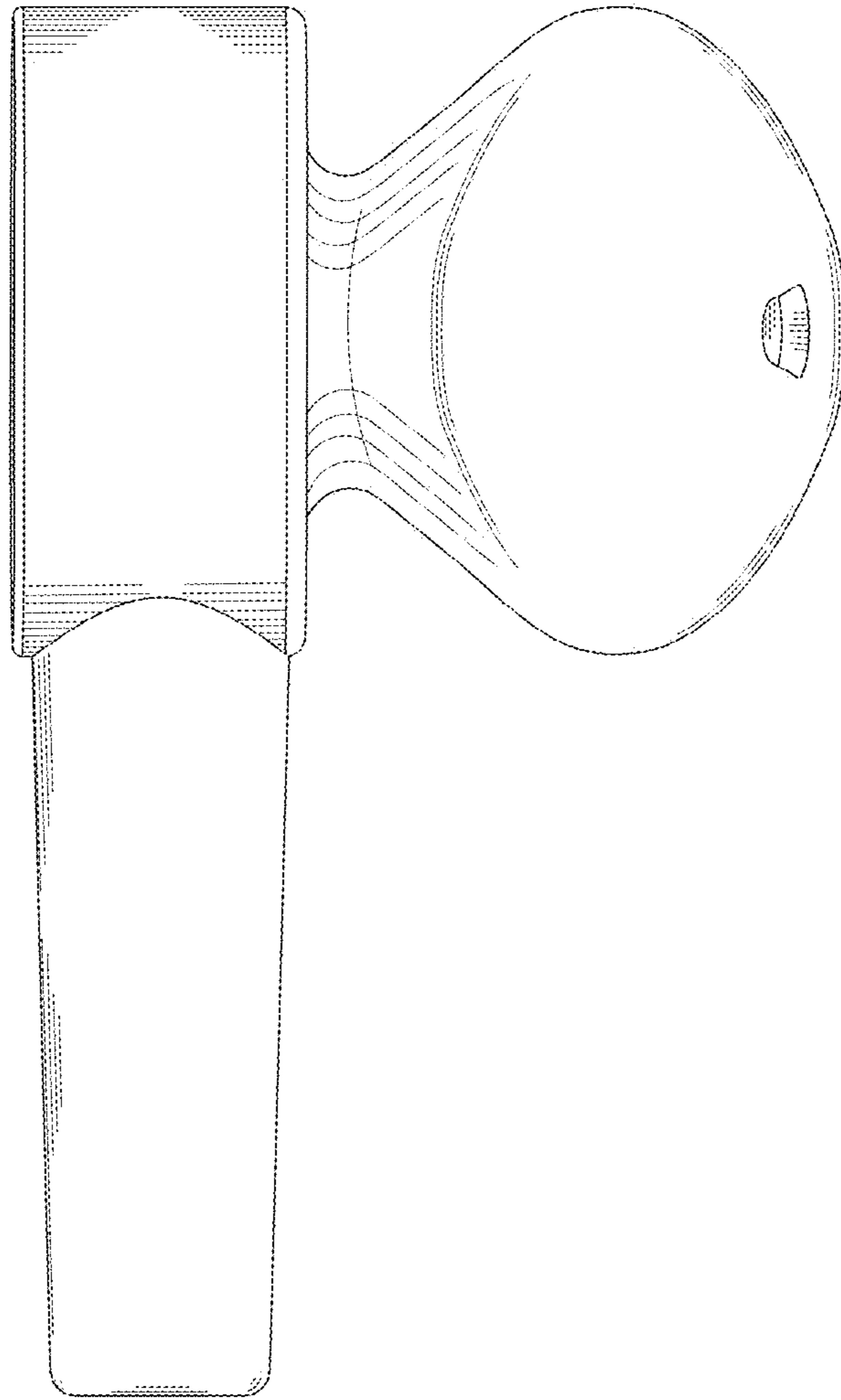


FIG. 12

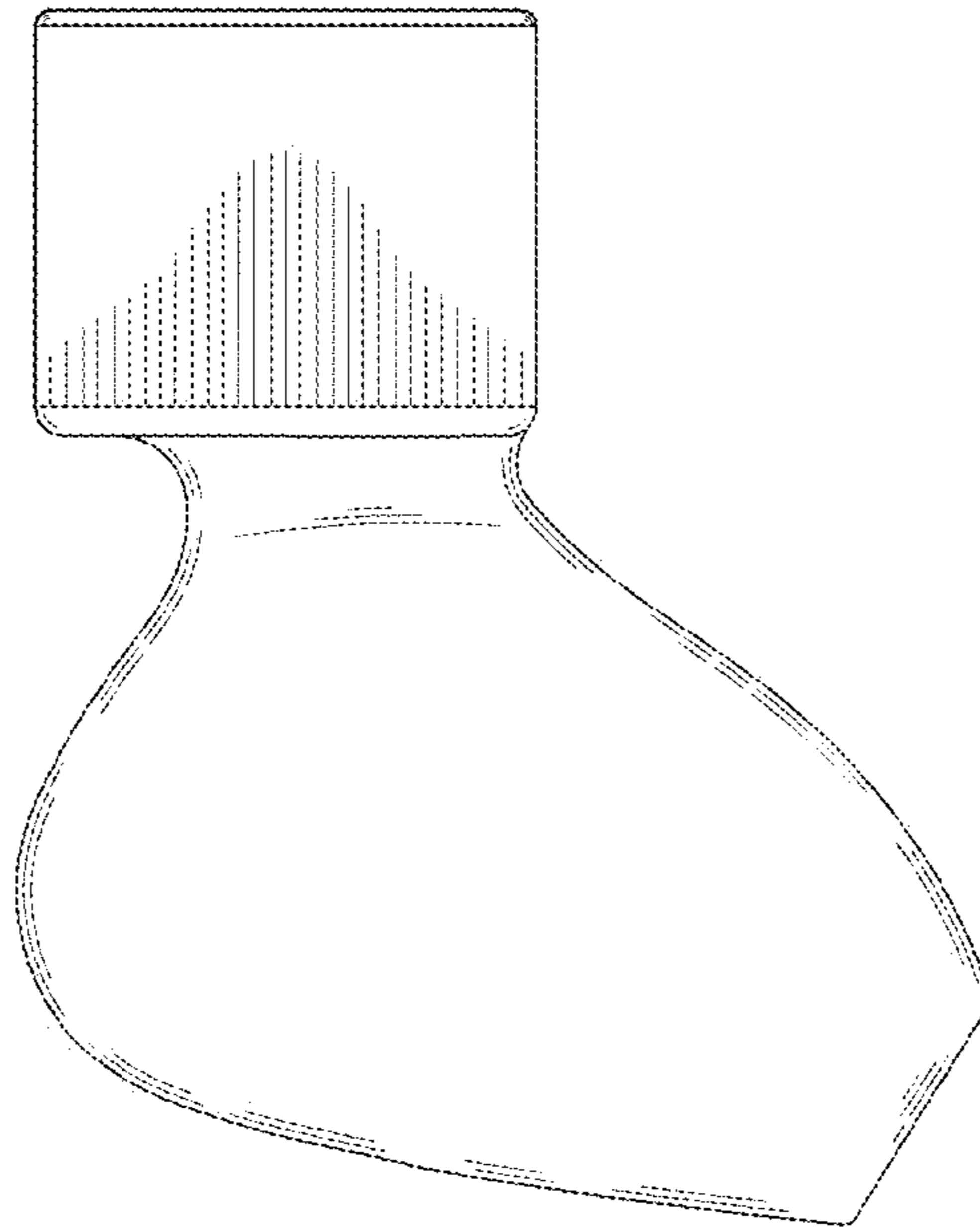


FIG. 13

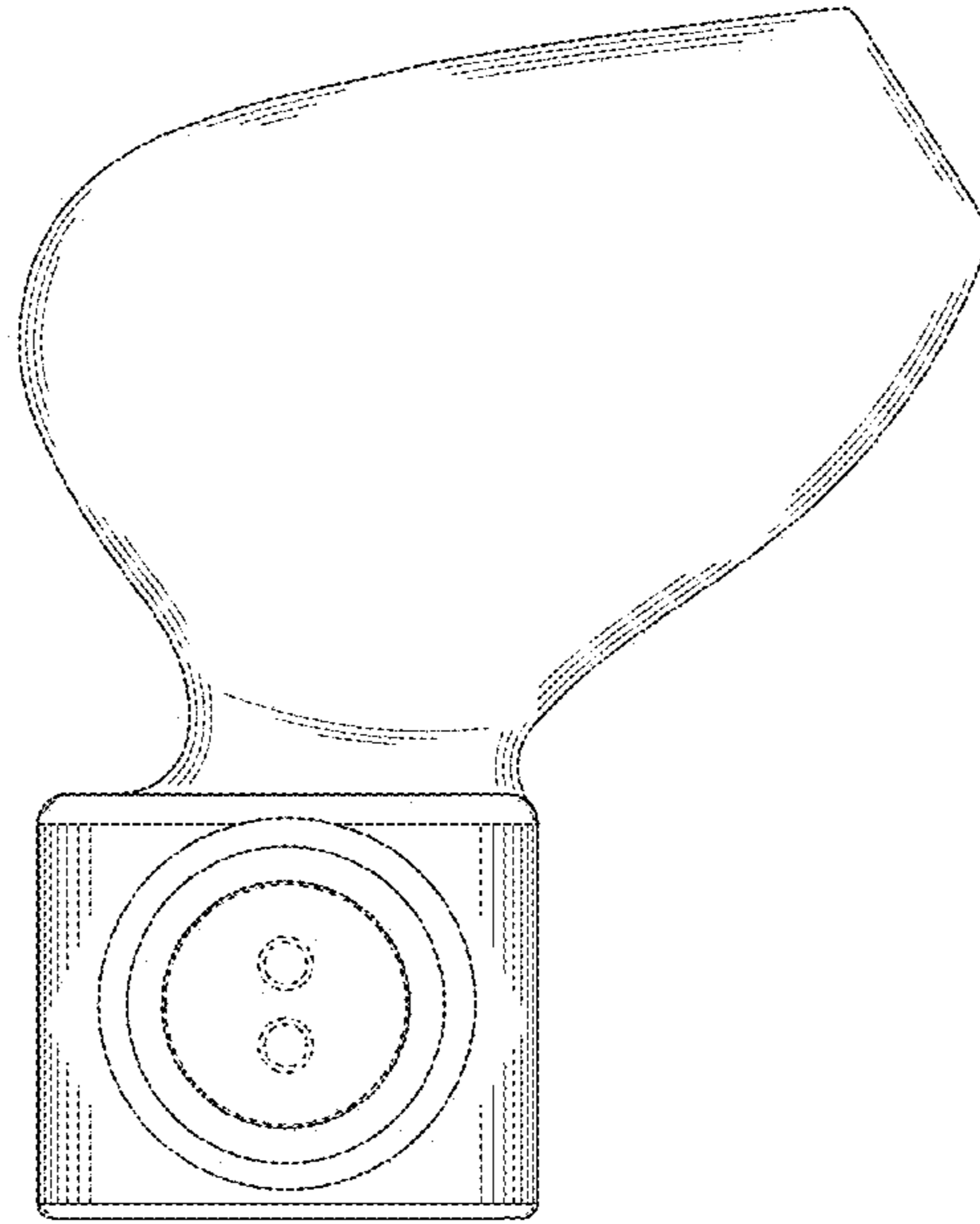


FIG. 14



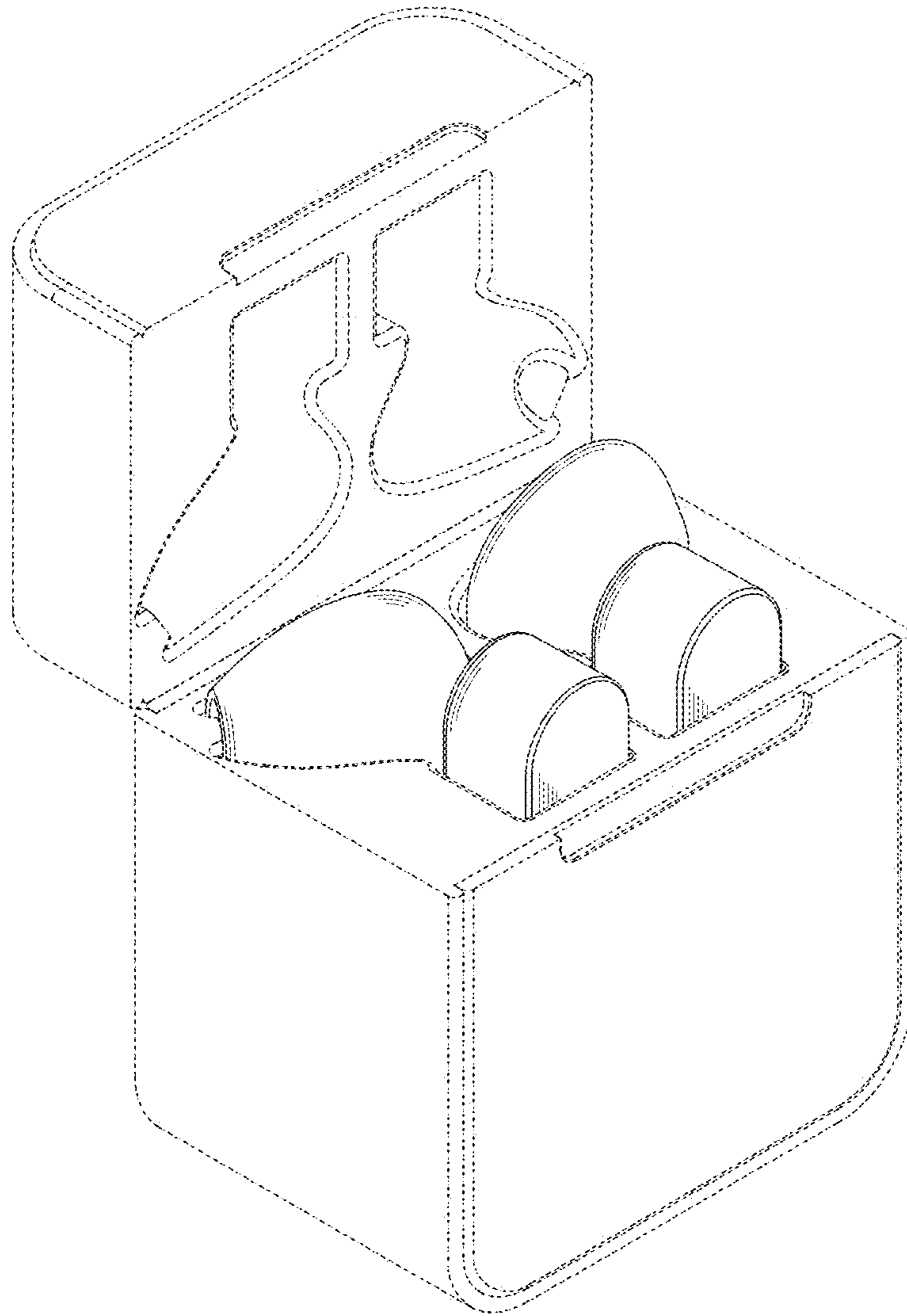


FIG. 15